

RSC90SG120B5H

SiC MOSFET Module

Preliminary Data

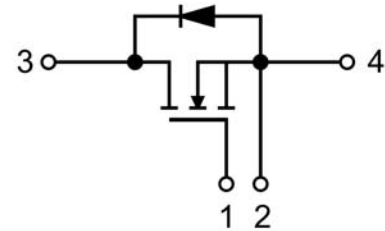
Features:

- High Speed Switching
- Low Switching Losses
- Kelvin Reference for Stable Operation
- Simple to Drive
- Lead Free, Compliant with RoHS Requirement

Applications:

- Solar Inverters
- High Voltage DC/DC Converters
- SMPS, UPS
- Induction Heating and Welding
- EV Charging Stations
- Motor Drives

Circuit Diagram



- (1)G(Gate)
- (2)S_G(Driver Source)
- (3)D(Drain)
- (4)S(Source)

SiC MOSFET

Absolute Maximum Ratings ($T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Description	Values	Units
V_{DSS}	Drain-Source Blocking Voltage	1200	V
V_{GSmax}	Gate-Source Voltage	Absolute Maximum Values	-10/+25
V_{GSop}		Recommended Operational Values	-5/+20
I_D	Continuous Drain Current	$V_{GS}=20\text{V}, T_C=25^\circ\text{C}$	90
		$V_{GS}=20\text{V}, T_C=100^\circ\text{C}$	66
$I_{D(pluse)}$	Pulsed Drain Current	Pulse width t_P limited by T_{Jmax}	240
P_D	Power Dissipation	$T_C=25^\circ\text{C}, T_J=175^\circ\text{C}$	600

Electrical Characteristics of MOSFET ($T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Description	Conditions	Min.	Typ.	Max.	Units
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=3mA$	1200			V
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=30mA$	2.0	2.8	4.0	V
		$V_{DS}=V_{GS}, I_D=30mA, T_J=175^\circ\text{C}$		1.9		V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS}=1200V, V_{GS}=0V$			1	mA
I_{GSS+}	Gate-Source Leakage Current	$V_{GS}=20V, V_{DS}=0V$			200	nA
I_{GSS-}		$V_{GS}=-5V, V_{DS}=0V$			-200	nA
$R_{DS(on)}$	On State Resistance	$V_{GS}=20V, I_{DS}=60A$		26	33	m Ω
		$V_{GS}=20V, I_{DS}=60A, T_J=175^\circ\text{C}$		45		m Ω
g_{fs}	Transconductance	$V_{DS}=20V, I_{DS}=60A$		24		S
C_{iss}	Input Capacitance	$V_{DS}=1000V, f=200kHz,$ $V_{GS}=0V, V_{AC}=25mV$		4000		pF
C_{oss}	Output Capacitance			219		pF
C_{rss}	Reverse Transfer Capacitance			24		pF
E_{oss}	C_{oss} Stored Energy			123		μJ
Q_G	Total Gate Charge	$V_{DS}=800V, V_{GS}=-5V \text{ to } +20V,$ $I_D=60A$		174		nC
Q_{GS}	Gate-Source Charge			54		nC
Q_{GD}	Gate-Drain Charge			51		nC
$t_{d(on)}$	Turn-on Delay Time	$V_{DD}=800V, V_{GS}=-5V \text{ to } +20V,$ $I_D=60A, R_{G(ext)}=0.8\Omega,$ $L=325\mu\text{H}$		14		ns
t_r	Rise Time			7		ns
$t_{d(off)}$	Turn-off Delay Time			19		ns
t_f	Fall Time			15		ns
E_{on}	Turn-on Switching Energy			576		μJ
E_{off}	Turn-off Switching Energy			120		μJ
$R_{G(int)-C}$	Internal Gate Resistance(chip)			1.0		Ω
$R_{G(int)-M}$	Internal Gate Resistance(module)			2.27		Ω
$R_{\theta JC}$	Thermal Resistance Junction-to-Case				0.25	$^\circ\text{C/W}$

Built-in SiC Body Diode

Electrical Characteristics of Diode ($T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Description	Conditions	Min.	Typ.	Max.	Units
I_S	Inverse Diode Continuous, Forward Current				102	A
V_{SD}	Diode Forward Voltage	$I_{SD}=30\text{A}$, $V_{GS}=-5\text{V}$		3.8		V
t_{rr}	Reverse Recovery Time	$I_{SD}=60\text{A}$, $V_R=800\text{V}$, $V_{GS}=-5\text{V}$, $di/dt=8.5\text{A/ns}$		10		ns
Q_{rr}	Reverse Recovery Charge			480		nC
I_{rr}	Peak Reverse Recovery Current			88		A

Module

Symbol	Description	Min.	Typ.	Max.	Units
V_{ISO}	Isolation Voltage (All Terminals Shorted)	$f=50\text{Hz}$, 1minute	2500		V
Internal Isolation			Si ₃ N ₄		
T_J	Maximum Junction Temperature			175	°C
T_{JOP}	Maximum Operating Junction Temperature Range	-55		+175	°C
T_{stg}	Storage Temperature	-55		+175	°C
$R_{\theta CS}$	Case-to-Sink Thermally (Conductive Grease Applied)			0.21	°C/W
CTI	Comparative Tracking Index	200			
T	Power Terminals Screw:M4	1.1		1.5	N·m
T	Mounting Screw:M4	1.1		1.5	N·m
G	Weight		30		g

Ordering Information Table

Device code

R	SC	90	SG	120	B5	H
①	②	③	④	⑤	⑥	⑦

- ① - MOSFET Module
- ② - SiC MOSFET
- ③ - Rated Current (90=90A)
- ④ - Circuit Configuration (Single)
- ⑤ - Rated Voltage (120=1200V)
- ⑥ - Package Type
- ⑦ - Test Level (Pass the Important Reliability Test-Industrial Grade)

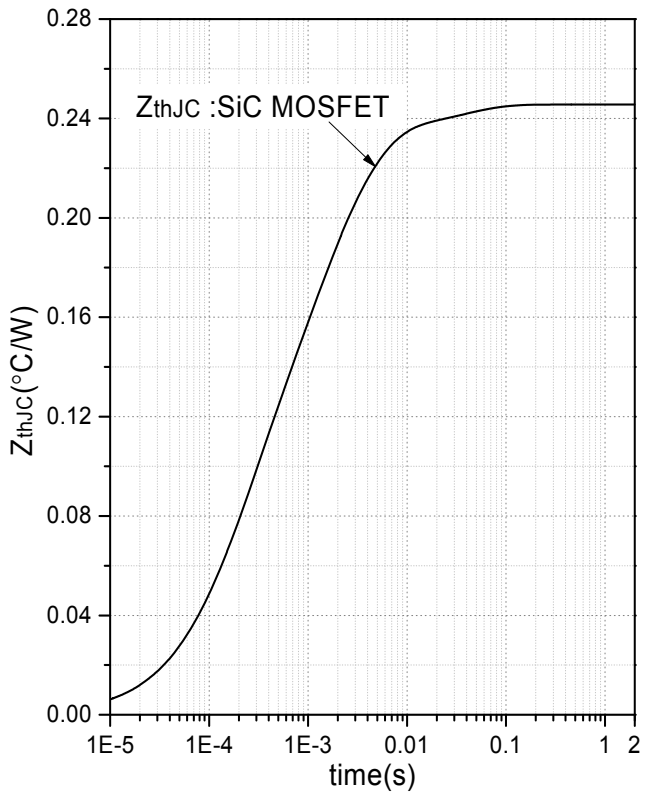
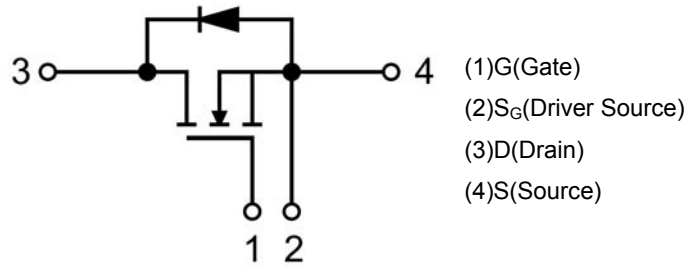


Fig.1 Transient Thermal Impedance (SiC MOSFET)

Internal Circuit



Package Outline (Unit: mm):

